

ABSTRACT OF THE DISCLOSURE

The connection structure is obtained by electrically
 connecting first electrodes on a first substrate 1 and
 5 second electrodes on a second substrate with an interposed
 anisotropic electroconductive adhesive layer 5 so as to
 satisfy Eq. 1 below

$$0.5 \times \{(A^1 C^1 + A^2 C^2) / (B+C)\} \leq X \leq 2 \times \{(A^1 C^1 + A^2 C^2) / (B+C)\} \quad (1)$$

10 where A^1 is the height of each first electrode, B^1 is the
 electrode width thereof, C^1 is the width of the
 interelectrode space, A^2 is the height of each second
 electrode, B^2 is the electrode width thereof, C^2 is the
 15 width of the interelectrode space ($B+C = B^1+C^1 = B^2+C^2$), and
 X is the thickness of the electroconductive adhesive layer
 prior to connection.